

1 Characteristics

Table 2. Absolute maximum rating ($T_j = 25\text{ °C}$, unless otherwise specified)

| Symbol | Parameter | | Value | Unit | |
|--------------------------|--|----------------------|-------------------------|-------------|-------------|
| $I_{T(RMS)}$ | On-state rms current (full sine wave) | | $T_c = 108\text{ °C}$ | 16 | A |
| | | | $T_c = 119\text{ °C}$ | 12 | |
| I_{TSM} | Non repetitive surge peak on-state current (full cycle, T_j initial = 25 °C) | $F = 50\text{ Hz}$ | $t = 20\text{ ms}$ | 120 | A |
| | | $F = 60\text{ Hz}$ | $t = 16.7\text{ ms}$ | 126 | |
| I^2t | I^2t Value for fusing | | $t_p = 10\text{ ms}$ | 95 | A^2s |
| V_{DRM} , V_{RRM} | Repetitive peak off-state voltage, gate open | | $T_j = 150\text{ °C}$ | 600 | V |
| | | | $T_j = 125\text{ °C}$ | 800 | |
| V_{DSM} , V_{RSM} | Non repetitive surge peak off-state voltage | $t_p = 10\text{ ms}$ | $T_j = 25\text{ °C}$ | 900 | V |
| di/dt | Critical rate of rise of on-state current $I_G = 2 \times I_{GT}$ | | $F = 100\text{ Hz}$ | 100 | $A/\mu s$ |
| I_{GM} | Peak gate current | | $t_p = 20\text{ }\mu s$ | 4 | A |
| $P_{G(AV)}$ | Average gate power dissipation | | | 1 | W |
| T_{stg} T_j | Storage junction temperature range | | | -40 to +150 | $^{\circ}C$ |
| | Operating junction temperature range | | | -40 to +150 | |
| T_L | Lead temperature for soldering during 10 s (at 4 mm from case for TO220AB-ins.) | | | 260 | $^{\circ}C$ |
| $V_{ins} (rms)$ | Insulation rms voltage, 1 minute, TO220AB ceramic insulated | | | 2500 | V |

Table 3. Electrical characteristics ($T_j = 25\text{ }^\circ\text{C}$, unless otherwise specified)

| Symbol | Test conditions | | Quadrant | | Value | Unit |
|-------------------|---|-----------------------------------|--------------|------|-------|------------------|
| $I_{GT}^{(1)}$ | $V_D = 12\text{ V}, R_L = 30\ \Omega$ | | I - II - III | MIN. | 0.5 | mA |
| | | | I - II - III | MAX. | 10 | mA |
| V_{GT} | $V_D = 12\text{ V}, R_L = 30\ \Omega$ | | All | MAX. | 1.3 | V |
| V_{GD} | $V_D = 800\text{ V}, R_L = 3.3\text{ k}\Omega, T_j = 125\text{ }^\circ\text{C}$ | | All | MIN. | 0.2 | V |
| $I_H^{(1)}$ | $I_T = 500\text{ mA}$ | | | MAX. | 25 | mA |
| I_L | $I_G = 1.2 I_{GT}$ | | I - III | MAX. | 20 | mA |
| | | | II | | 30 | |
| $dV/dt^{(1)}$ | $V_D = 67\% \times 800\text{ V gate open}$ | $T_j = 125\text{ }^\circ\text{C}$ | | MIN. | 100 | V/ μs |
| | $V_D = 67\% \times 600\text{ V gate open}$ | $T_j = 150\text{ }^\circ\text{C}$ | | | 50 | |
| $(dI/dt)_c^{(1)}$ | $(dV/dt)_c = 0.1\text{ V}/\mu\text{s}$ | $T_j = 125\text{ }^\circ\text{C}$ | | MIN. | 9 | A/ms |
| | $(dV/dt)_c = 10\text{ V}/\mu\text{s}$ | $T_j = 125\text{ }^\circ\text{C}$ | | | 3 | |
| | $(dV/dt)_c = 0.1\text{ V}/\mu\text{s}$ | $T_j = 150\text{ }^\circ\text{C}$ | | | 5.4 | |
| | $(dV/dt)_c = 10\text{ V}/\mu\text{s}$ | $T_j = 150\text{ }^\circ\text{C}$ | | | 1.8 | |
| t_{GT} | gate controlled turn on time $I_{TM} = 13\text{ A}, V_D = 400\text{ V}, I_G = 100\text{ mA}, dI_G/dt = 100\text{ mA}/\mu\text{s}, R_L = 30\ \Omega$ | | I - II - III | TYP. | 2 | μs |

1. For both polarities of A2 referenced to A1

Table 4. Static characteristics

| Symbol | Test conditions | | | Value | Unit |
|------------------------|--|-----------------------------------|------|-------|------------------|
| $V_{TM}^{(1)}$ | $I_{TM} = 22.6\text{ A}, t_p = 380\ \mu\text{s}$ | $T_j = 25\text{ }^\circ\text{C}$ | MAX. | 1.55 | V |
| $V_{to}^{(1)}$ | Threshold voltage | | | 0.85 | V |
| $R_d^{(1)}$ | Dynamic resistance | | | 30 | $\text{m}\Omega$ |
| I_{DRM} I_{RRM} | $V_{DRM} = V_{RRM} = 800\text{ V}$ | $T_j = 25\text{ }^\circ\text{C}$ | MAX. | 5 | μA |
| | | $T_j = 125\text{ }^\circ\text{C}$ | | 1 | mA |
| | $V_{DRM} = V_{RRM} = 600\text{ V}$ | $T_j = 150\text{ }^\circ\text{C}$ | | 3.6 | |

1. for both polarities of A2 referenced to A1

Table 5. Thermal resistance

| Symbol | Parameter | Value | Unit |
|---------------|-----------------------|-------|---------------------------|
| $R_{th(j-c)}$ | Junction to case (AC) | 2.1 | $^\circ\text{C}/\text{W}$ |
| $R_{th(j-a)}$ | Junction to ambient | 60 | $^\circ\text{C}/\text{W}$ |

Figure 1. Maximum power dissipation versus on-state rms current (full cycle)

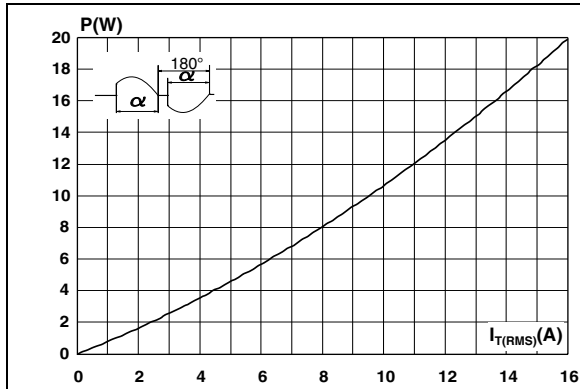


Figure 2. On-state rms current versus case temperature (full cycle)

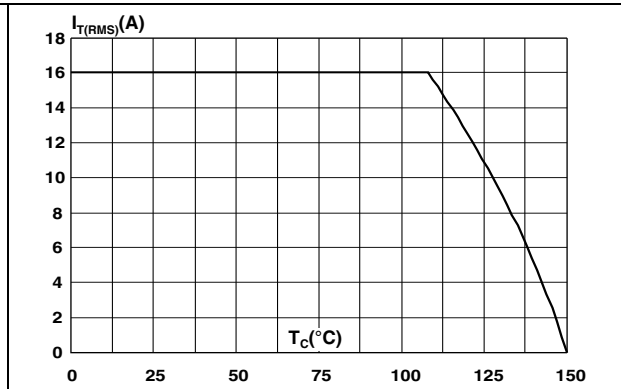


Figure 3. On-state rms current versus ambient temperature (free air convection)

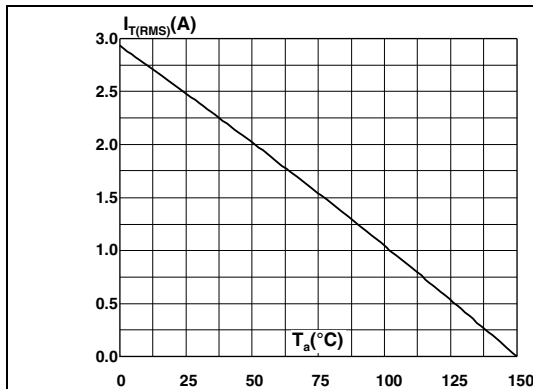


Figure 4. Relative variation of thermal impedance versus pulse duration

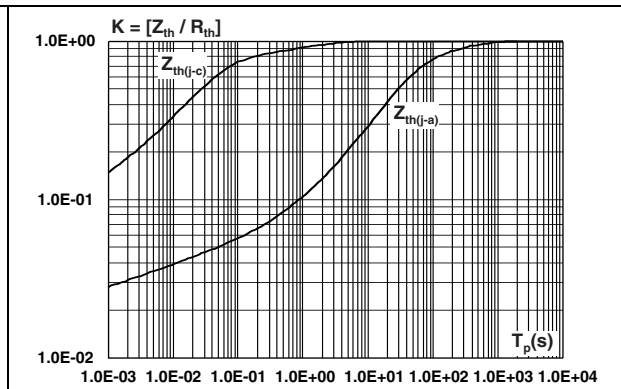


Figure 5. On-state characteristics (maximum values)

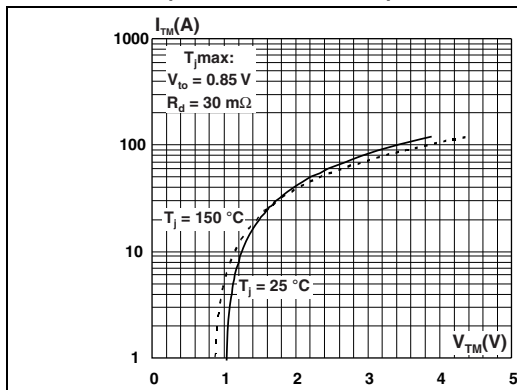


Figure 6. Surge peak on-state current versus number of cycles

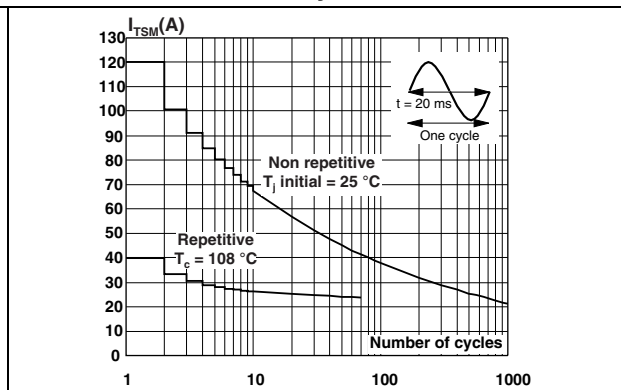


Figure 7. Non repetitive surge peak on-state current and corresponding values of I^2t

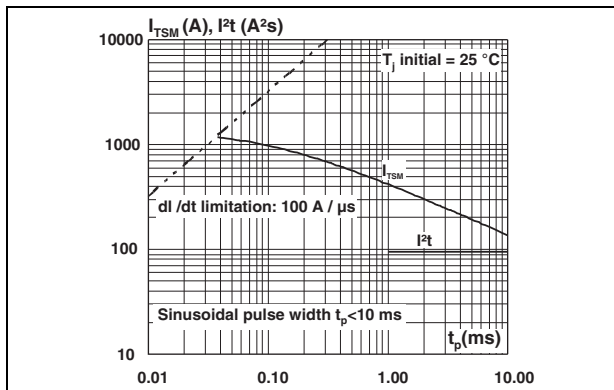


Figure 8. Relative variation of gate trigger current versus junction temperature (typical values)

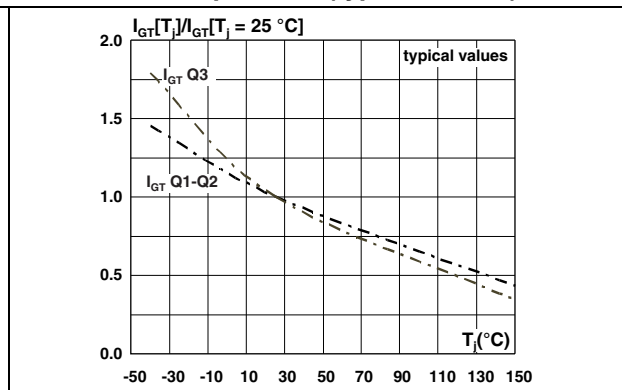


Figure 9. Relative variation of gate trigger voltage versus junction temperature (typical values)

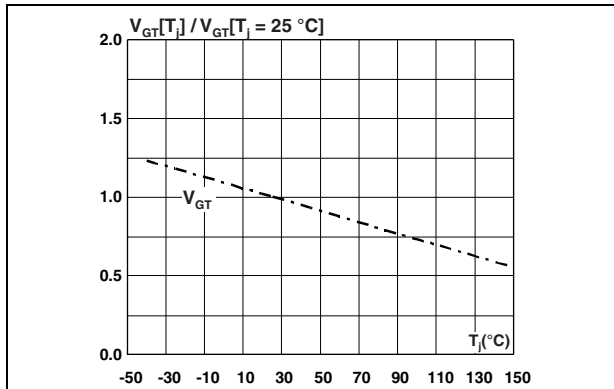


Figure 10. Relative variation of holding current and latching current versus junction temperature

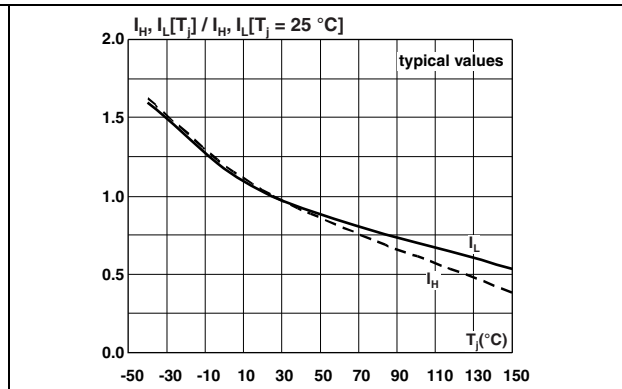


Figure 11. Relative variation of critical rate of decrease of current (di/dt)_c versus reapplied (dV/dt)_c

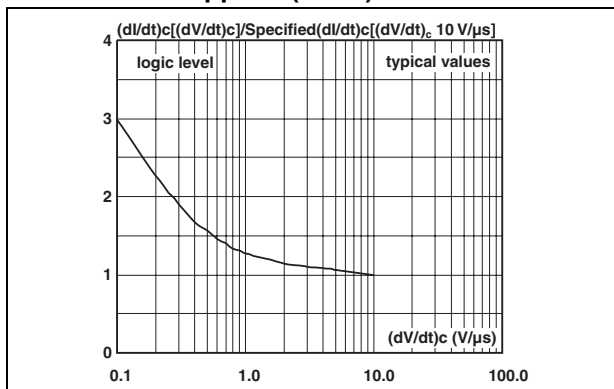


Figure 12. Relative variation of critical rate of decrease of current (di/dt)_c versus junction temperature

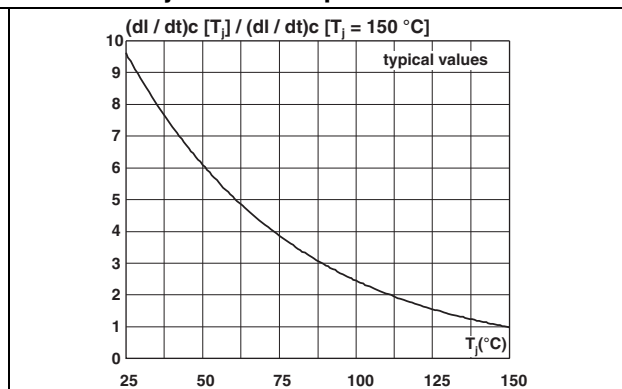


Figure 13. Relative variation of static dV/dt immunity versus junction temperature

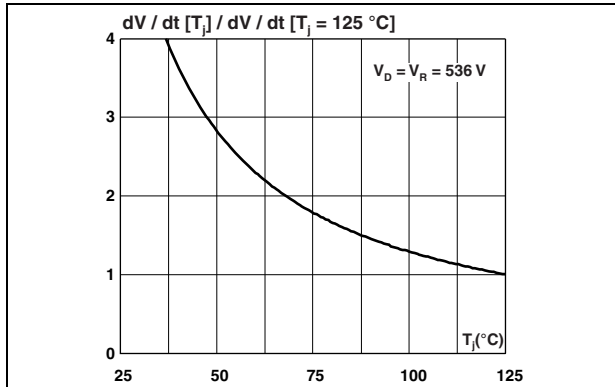


Figure 14. Relative variation of static dV/dt immunity versus junction temperature

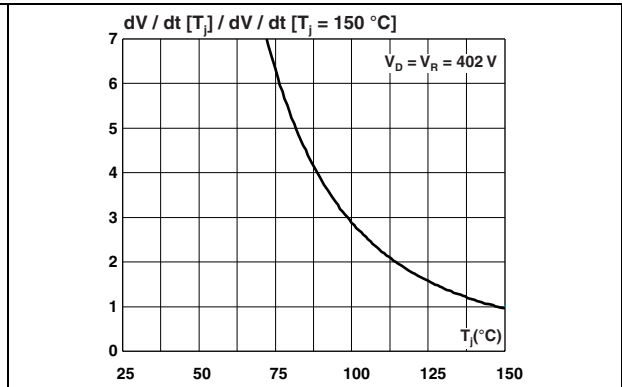
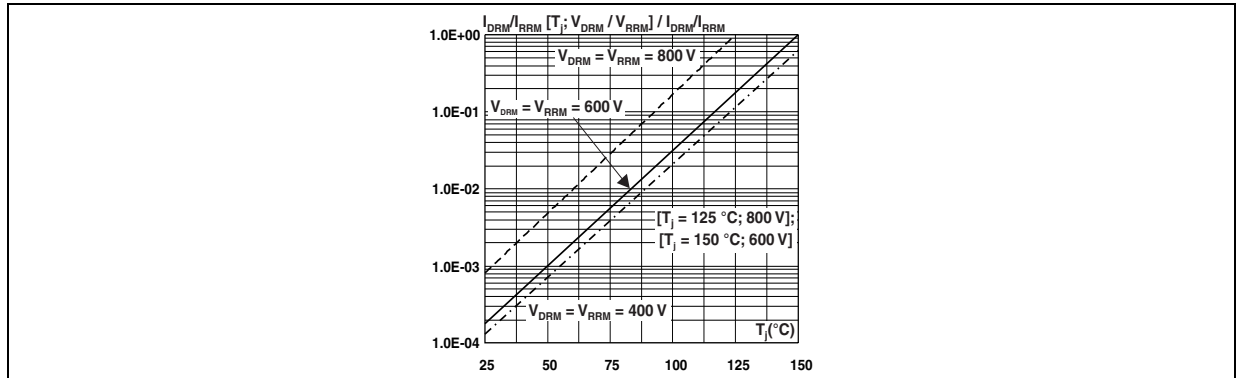


Figure 15. Relative variation of leakage current versus junction temperature for different values of blocking voltage



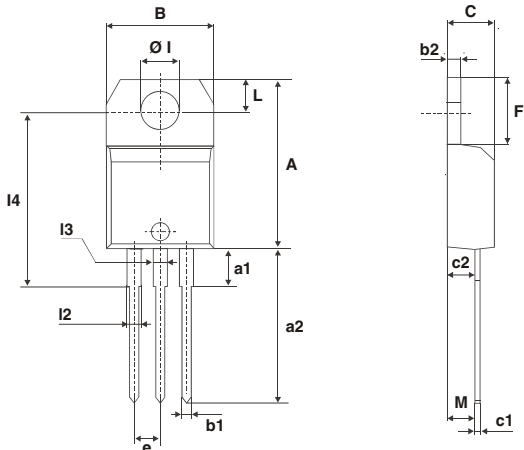
2 Package information

- Epoxy meets UL94, V0
- Recommended torque value: 0.4 to 0.6 N-m

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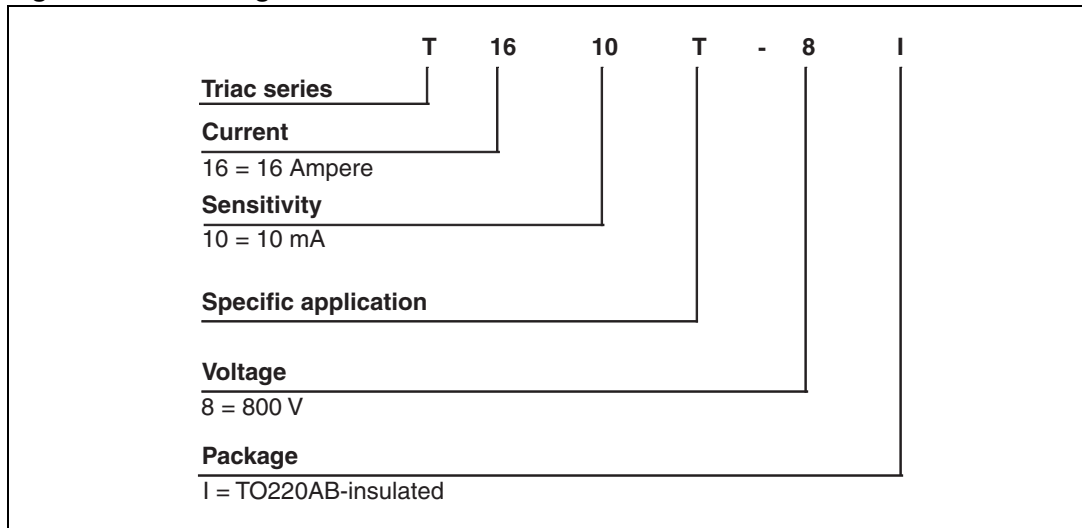
Table 6. TO-220AB insulated dimensions

| Ref. | Dimensions | | | | | |
|------|-------------|-------|-------|--------|-------|-------|
| | Millimeters | | | Inches | | |
| | Min. | Typ. | Max. | Min. | Typ. | Max. |
| A | 15.20 | | 15.90 | 0.598 | | 0.625 |
| a1 | | 3.75 | | | 0.147 | |
| a2 | 13.00 | | 14.00 | 0.511 | | 0.551 |
| B | 10.00 | | 10.40 | 0.393 | | 0.409 |
| b1 | 0.61 | | 0.88 | 0.024 | | 0.034 |
| b2 | 1.23 | | 1.32 | 0.048 | | 0.051 |
| C | 4.40 | | 4.60 | 0.173 | | 0.181 |
| c1 | 0.49 | | 0.70 | 0.019 | | 0.027 |
| c2 | 2.40 | | 2.72 | 0.094 | | 0.107 |
| e | 2.40 | | 2.70 | 0.094 | | 0.106 |
| F | 6.20 | | 6.60 | 0.244 | | 0.259 |
| ØI | 3.75 | | 3.85 | 0.147 | | 0.151 |
| I4 | 15.80 | 16.40 | 16.80 | 0.622 | 0.646 | 0.661 |
| L | 2.65 | | 2.95 | 0.104 | | 0.116 |
| I2 | 1.14 | | 1.70 | 0.044 | | 0.066 |
| I3 | 1.14 | | 1.70 | 0.044 | | 0.066 |
| M | | 2.60 | | | 0.102 | |



3 Ordering information scheme

Figure 16. Ordering information scheme



4 Ordering information

Table 7. Ordering information

| Order code | Marking | Package | Weight | Base qty | Delivery mode |
|------------|-----------|-----------------------|--------|----------|---------------|
| T1610T-8I | T1610T-8I | TO-220AB insulated | 2.3 | 50 | Tube |

5 Revision history

Table 8. Document revision history

| Date | Revision | Changes |
|-------------|----------|---|
| 08-Aug-2011 | 1 | First issue. |
| 20-Jan-2012 | 2 | Corrected subscripting error in Table 3 . |
| 25-Apr-2012 | 3 | Updated UL certification. |

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